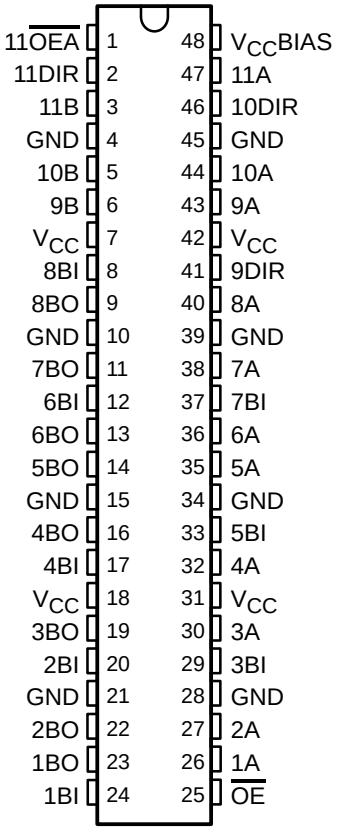
- **Support the VME64 ETL Specification**
- **Reduced, TTL-Compatible, Input Threshold Range**
- **High-Drive Outputs (I_{OH} = –60 mA, I_{OL} = 90 mA) Support 25-Ω Incident-Wave Switching**
- **V_{CC}BIAS Pin Minimizes Signal Distortion During Live Insertion**
- **Internal Pullup Resistor on $\overline{OE}$ Keeps Outputs in High-Impedance State During Power Up or Power Down**
- **Members of the Texas Instruments (TI) *Widebus*™ Family**
- **State-of-the-Art *EPIC*-II*B*™ BiCMOS Design Significantly Reduces Power Dissipation**
- **Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise**
- **25-Ω Series Damping Resistor on B Port**
- **Bus Hold on Data Inputs Eliminates the Need for External Pullup Resistors**
- **Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin-Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

SN54ABTE16246 . . . WD PACKAGE
SN74ABTE16246 . . . DGG OR DL PACKAGE
(TOP VIEW)



description

The ’ABTE16246 are 11-bit noninverting transceivers designed for asynchronous two-way communication between buses. These devices have open-collector and 3-state outputs. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ($\overline{OE}$) input can be used to disable the device so that the buses are effectively isolated. When $\overline{OE}$ is low, the device is active.

The B port has a 25-Ω series output resistor to reduce ringing. Active bus-hold inputs are also found on the B port to hold unused or floating inputs at a valid logic level.

The A port provides for the precharging of the outputs via V_{CC}BIAS, which establishes a voltage between 1.3 V and 1.7 V when V_{CC} is not connected.

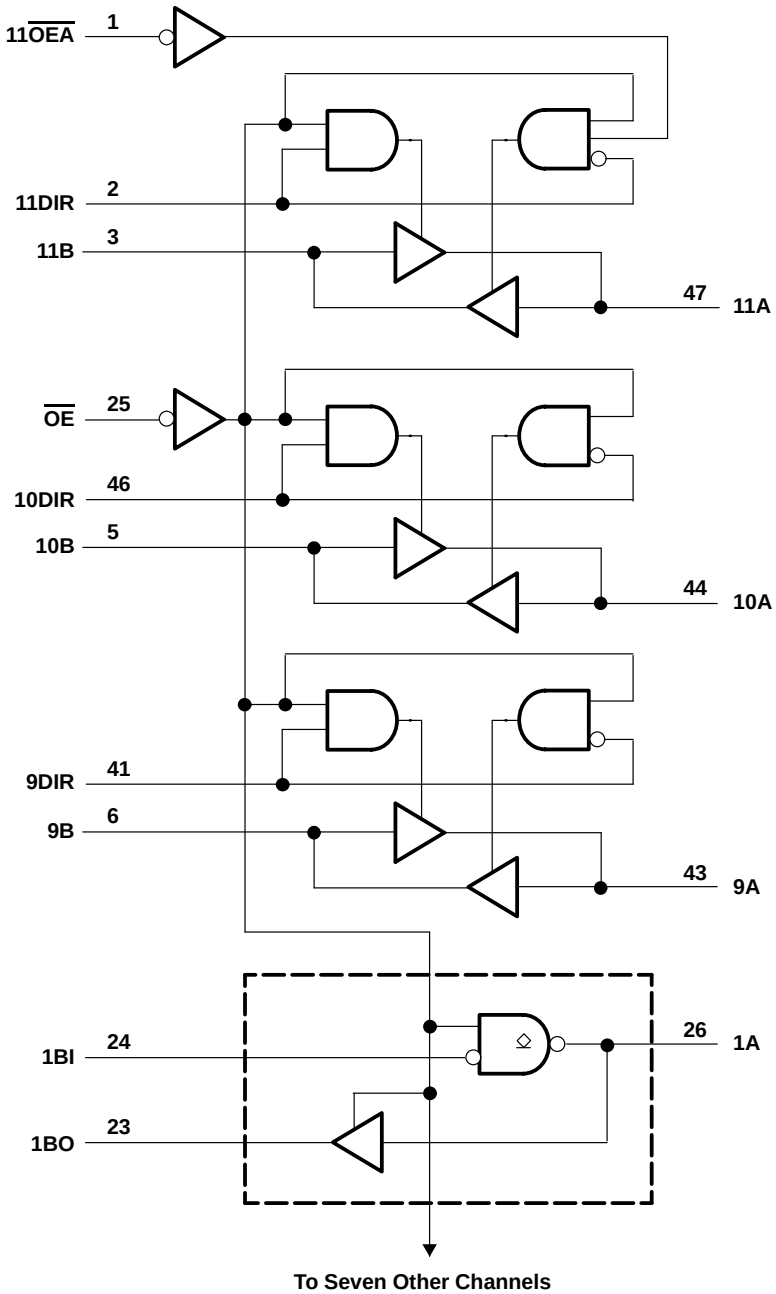
The SN74ABTE16246 is available in TI’s shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABTE16246 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTE16246 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	A data to B bus
L	H	B data to A bus
H	X	Isolation

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . . –0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1) . . . . . –0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O . . . . . –0.5 V to 5.5 V
Current into any output in the low state, I_O . . . . . 128 mA
Input clamp current, I_{IK} (V_I < 0) . . . . . –18 mA
Output clamp current, I_{OK} (V_O < 0) . . . . . –50 mA
Maximum power dissipation at T_A = 55°C (in still air) (see Note 2): DGG package . . . . . 0.85 W
DL package . . . . . 1.2 W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

recommended operating conditions (see Note 3)

			SN54ABTE16246			SN74ABTE16246			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	$\overline{OE}$	2			2			V
		Except $\overline{OE}$	1.6			1.6			
V_{IL}	Low-level input voltage	$\overline{OE}$			0.8			0.8	V
		Except $\overline{OE}$			1.4			1.4	
V_{OH}	High-level output voltage	1A–8A			5.5	0		5.5	V
V_I	Input voltage		0		V_{CC}	0		V_{CC}	V
I_{OH}	High-level output current	B bus			–12			–12	mA
		9A–11A			–24			–64	
I_{OL}	Low-level output current	B bus			12			12	mA
		A bus			64			90	
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			10			10	ns/V
T_A	Operating free-air temperature		–55		125	–40		85	°C

NOTE 3: Unused pins (input or A-bus I/O) must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ABTE16246			SN74ABTE16246			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = –18 mA			–1.2			–1.2	V
V_{OH}	B port	V_{CC} = 5.5 V,	I_{OH} = –100 µA			V_{CC}–0.2			V_{CC}–0.2	V
		V_{CC} = 4.5 V	I_{OH} = –1 mA	2.4			2.4			
			I_{OH} = –12 mA	2			2			
	9A–11A	V_{CC} = 5.5 V,	I_{OH} = –1 mA			4.5			4.5	
		V_{CC} = 4.5 V	I_{OH} = –32 mA	2.4			2.4			
			I_{OH} = –64 mA				2			
I_{OH}	1A–8A	V_{CC} = 4.5 V,	V_{OH} = 5.5 V			20			20	µA
V_{OL}	B port	V_{CC} = 4.5 V	I_{OL} = 1 mA			0.4			0.4	V
			I_{OL} = 12 mA						0.8	
	A port	V_{CC} = 4.5 V	I_{OL} = 64 mA			0.55			0.55	
			I_{OL} = 90 mA						0.9	
$I_{I(hold)}$	B port	V_{CC} = 4.5 V	V_I = 0.8 V	100			100			µA
			V_I = 2 V	–100			–100			
		V_{CC} = 5.5 V,	V_I = 0 to 5.5 V			±500			±500	
I_I	Control inputs	V_{CC} = 5.5 V,	V_I = V_{CC} or GND			±1			±1	µA
	A or B ports					±20			±20	
I_{OZH}‡	9A–11A	V_{CC} = 5.5 V,	V_O = 2.7 V			10			10	µA
I_{OZL}‡	9A–11A	V_{CC} = 5.5 V,	V_O = 0.5 V			–10			–10	µA
I_O	A port	V_{CC} = 5.5 V,	V_O = 2.5 V	–50	–120	–180	–50		–180	mA
	B port			–25	–52	–90	–25		–90	
I_{off}		V_{CC} = 0, V_I or V_O ≤ 4.5 V,	V_{CC}BIAS = 0			±100			±100	µA
I_{CC}	A or B ports	V_{CC} = 5.5 V, I_O = 0, V_I = V_{CC} or GND	Outputs high		28	36		28	36	mA
			Outputs low		38	48		38	48	
			Outputs disabled		20	32		20	32	
I_{CCD}	A or B ports	V_{CC} = 5 V, C_L = 50 pF	$\overline{OE}$ high		0.02			0.02		mA/ MHz
			$\overline{OE}$ low		0.33			0.33		
C_i	Control inputs	V_I = 2.5 V or 0.5 V			2.5	4		2.5	4	pF
C_{io}	I/O ports	V_O = 2.5 V or 0.5 V			4.5	8		4.5	8	pF

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

live-insertion specifications over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS		SN54ABTE16246			SN74ABTE16246			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
I_{CC} (V_{CC}BIAS)		V_{CC} = 0 to 4.5 V, V_{CC}BIAS = 4.5 V to 5.5 V, $I_{O(DC)}$ = 0			250	700		250	700	µA
		V_{CC} = 4.5 V to 5.5 V‡, V_{CC}BIAS = 4.5 V to 5.5 V, $I_{O(DC)}$ = 0				20			20	
V_O	A port	V_{CC} = 0	V_{CC}BIAS = 4.5 V to 5.5 V	1.1	1.5	1.9	1.1	1.5	1.9	V
			V_{CC}BIAS = 4.75 V to 5.25 V	1.3	1.5	1.7	1.3	1.5	1.7	
I_O	A port	V_{CC} = 0	V_O = 0, V_{CC}BIAS = 4.5 V	–20		–100	–20		–100	µA
			V_O = 3 V, V_{CC}BIAS = 4.5 V	20		100	20		100	

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ V_{CC} – 0.5 V < V_{CC}BIAS

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 5 V, T_A = 25°C			SN54ABTE16246		SN74ABTE16246		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	1.5	3.1	4.2	1.5	5.4	1.5	5.2	ns
t_{PHL}			1.5	3.5	4.6	1.5	5.4	1.5	5.2	
t_{PLH}	9B–11B	9A–11A	1.5	3	3.8	1.5	4.7	1.5	4.5	ns
t_{PHL}			1.5	3.2	4	1.5	4.7	1.5	4.5	
t_{PLH}§	1B–8B	1A–8A	1.5	3.2	4	1.5	4.7	1.5	4.5	ns
t_{PLH}¶			7.5	8.9	9.7	7.5	10.6	7.5	10.3	
t_{PHL}			1.5	3.2	4	1.5	4.7	1.5	4.5	
t_{PZH}	$\overline{OE}$	9A–11A	2	4.3	5.3	2	6.4	2	6.2	ns
t_{PZL}		1A–11A	2	4.4	5.4	2	7	2	6.8	
t_{PZH}	$\overline{OE}$	B	2	4.3	6	2	7.3	2	7.1	ns
t_{PZL}			2	4.5	6.4	2	7.5	2	7.3	
t_{PHZ}	$\overline{OE}$	9A–11A	2	4.2	5.9	2	7	2	6.7	ns
t_{PLZ}		1A–11A	2	3.5	4.6	2	5.4	2	5.1	
t_{PHZ}	$\overline{OE}$	B	2.5	4.3	6.2	2.5	7.2	2.5	7	ns
t_{PLZ}			2	3.6	5	2	5.8	2	5.5	

§ Measurement point is V_{OL} + 0.3 V.
¶ Measurement point is V_{OL} + 1.5 V.

extended switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Note 4 and Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD	V_{CC} = 5 V, T_A = 25°C			SN54ABTE16246		SN74ABTE16246		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	9B–11B	9A–11A	R_X = 13 Ω	1.5	3.2	4	1.5	5	1.5	4.8	ns
t_{PHL}				1.5	3.8	4.7	1.5	5.8	1.5	5.6	
t_{PHL}	1B–8B	1A–8A	R_X = 13 Ω	1.5	3.3	4.2	1.5	5	1.5	4.8	ns
t_{PLH}	9B–11B	9A–11A	R_X = 26 Ω	1.5	3.1	4	1.5	4.8	1.5	4.6	ns
t_{PHL}				1.5	3.5	4.4	1.5	5.2	1.5	4.9	
t_{PHL}	1B–8B	1A–8A	R_X = 26 Ω	1.5	3.1	4	1.5	4.6	1.5	4.4	ns
t_{PLH}	9B–11B	1A–8A	R_X = 56 Ω	1.5	3	3.8	1.5	4.7	1.5	4.5	ns
t_{PHL}				1.5	3.3	4.2	1.5	5.1	1.5	4.7	
t_{PHL}	1B–8B	1A–8A	R_X = 56 Ω	1.5	3	4	1.5	4.6	1.5	4.4	ns
$t_{sk(p)}$	B	A	R_X = Open		0.1	0.6		2		2	ns
	A	B			0.4	0.8		2		2	
	B	A	R_X = 26 Ω		0.3	0.8		2		2	
$t_{sk(o)}$	B	A	R_X = Open		0.3	0.7		1.3		1.3	ns
	A	B			0.7	1.1		1.3		1.3	
	B	A	R_X = 26 Ω		0.5	1		1.3		1.3	
t_t†	B	A	R_X = 26 Ω	0.5	0.8	1.5	0.5	1.5	0.5	1.5	ns
t_t‡	A	B	Rise or fall time 10%–90%	3.5	5.5	7.3	3.5	8.1	3.5	7.9	ns

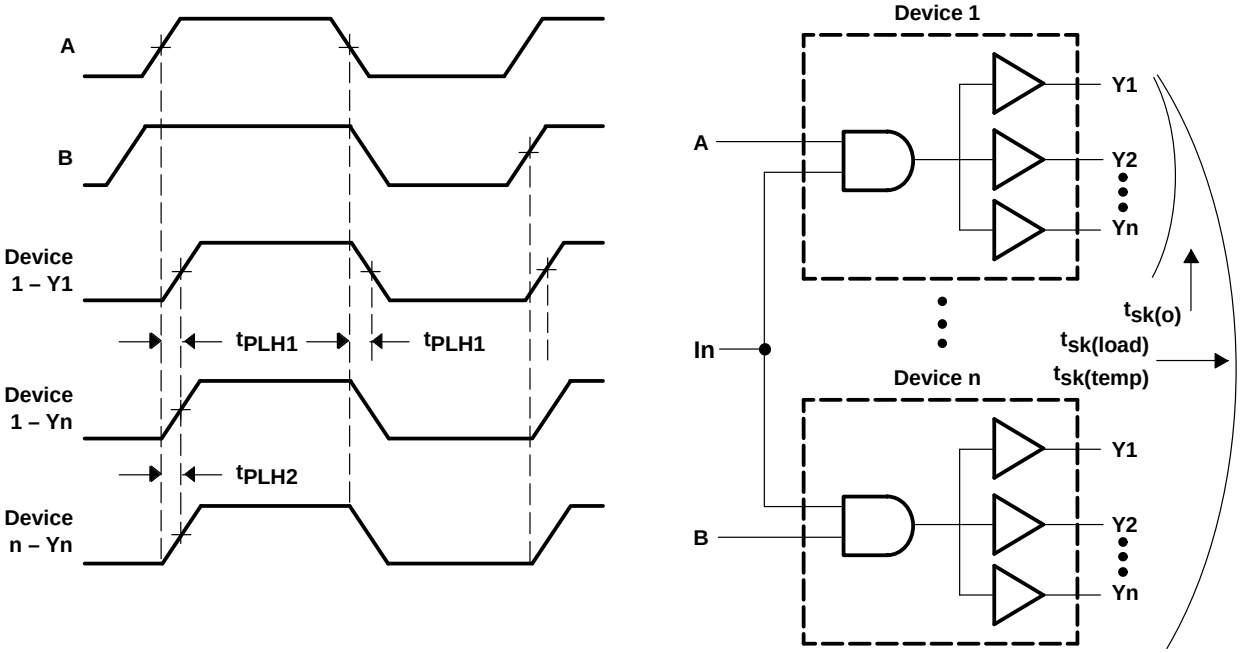
† t_t is measured between 1 V and 2 V of the output waveform.
‡ t_t is measured between 10% and 90% of the output waveform.
NOTE 4: Limits are specified but not production tested.

extended output characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (see Note 4 and Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	LOAD	SN54ABTE16246		SN74ABTE16246		UNIT
					MIN	MAX	MIN	MAX	
$t_{sk(temp)}$	A	B	V_{CC} = Constant, ΔT_A = 20°C			3		2.5	ns
	B	A		R_X = 56 Ω		4.5		4	
$t_{sk(load)}$	B	A	V_{CC} = Constant, Temperature = Constant	R_X = 13, 26, or 56 Ω		4.5		4	ns

NOTE 4: Limits are specified but not production tested.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. Pulse skew, $t_{sk(p)}$, is defined as the difference in propagation delay times t_{PLH1} and t_{PHL1} on the same terminal at identical operating conditions.

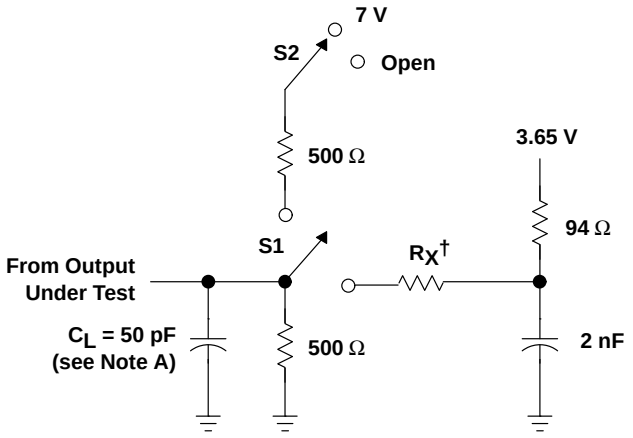
B. Output skew, $t_{sk(o)}$, is defined as the difference in propagation delay of the fastest and slowest paths on a single device that originate at either a single input or multiple simultaneously switched inputs (e.g., $|t_{PLH1} - t_{PLH2}|$).

C. Temperature skew, $t_{sk(temp)}$, is the output skew of two devices, both having the same value of $V_{CC} \pm 1\%$ and with package temperature differences of 20°C.

D. Load skew, $t_{sk(load)}$, is measured with R_X in Figure 2 at 13 Ω for one unit and 56 Ω for the other unit.

Figure 1. Voltage Waveforms for Extended Characteristics

PARAMETER MEASUREMENT INFORMATION

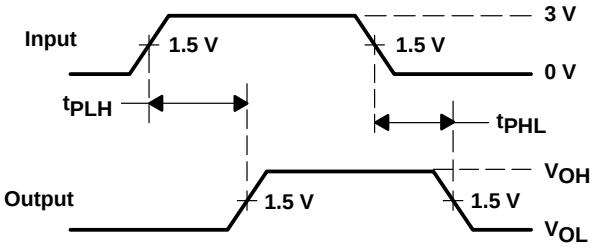


† R_X = 13, 26, or 56 Ω

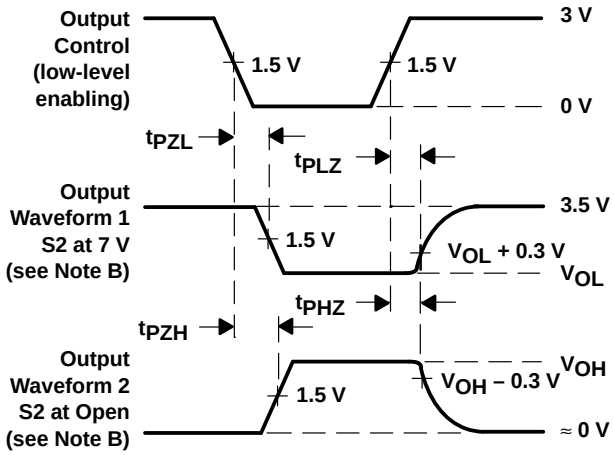
LOAD CIRCUIT FOR OUTPUTS

SWITCHING TABLE LOADS	S1	S2
t_{PLH}/t_{PHL} (9A–11A and B port)	Up	Open
t_{PLH}/t_{PHL} (1A–8A)	Up	7 V
t_{PLZ}/t_{PZL}	Up	7 V
t_{PHZ}/t_{PZH} (except 1A–8A)	Up	Open

EXTENDED SWITCHING TABLE LOADS	S1	S2
$t_{PLH}/t_{PHL}/t_{sk}$ (A port)	Down	X
$t_{PLH}/t_{PHL}/t_{sk}$ (B port)	Up	Open
t_t (A port) (see Note E)	Down	X
t_t (B port) (see Note F)	Up	Open



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns
D. The outputs are measured one at a time with one transition per measurement.
E. t_t is measured between 1 V and 2 V of the output waveform.
F. t_t is measured between 10% and 90% of the output waveform.

Figure 2. Load Circuit and Voltage Waveforms

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